LITEON®
OPTOELECTRONICS

Photocoupler

Product Data Sheet

LTV-217-G

(Half Pitch LO Own Brand - 1CH Halogen Free Series)

Spec No.: DS70-2009-0016

Effective Date: 09/06/2012

Revision: A

LITE-ON DCC

RELEASE

BNS-OD-FC001/A4

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FEATURES

* Current transfer ratio
  (CTR : MIN. 50% at I_F = 5mA, V_{CE} = 5V)
* Isolation voltage between input and output LTV-217 Series
  (Viso = 3.75 KVrms)
* Employs double transfer mold technology

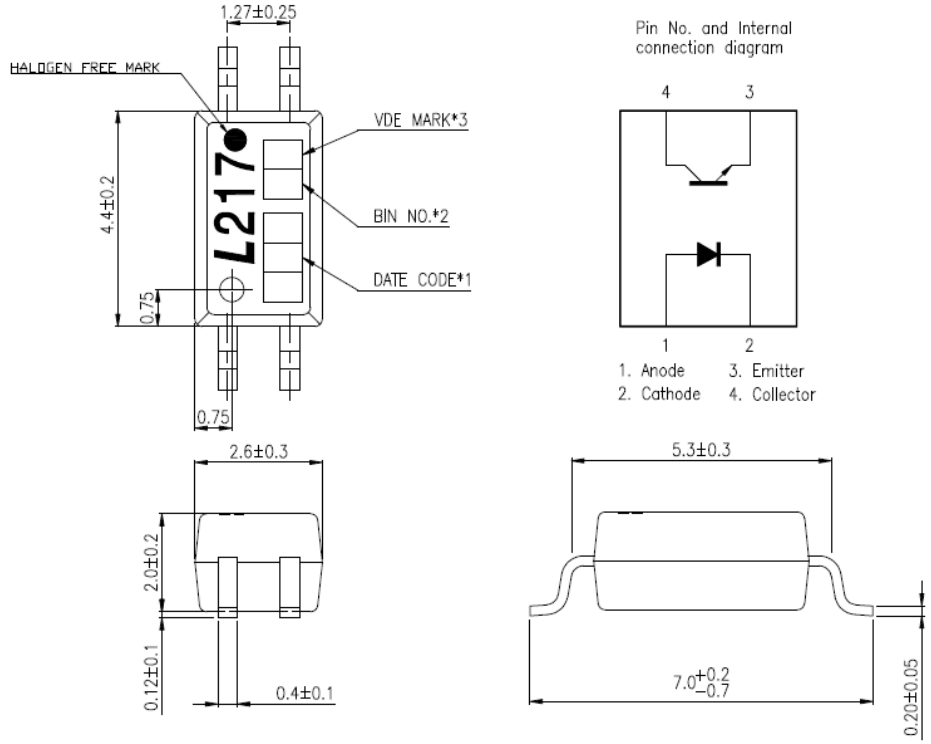
* Safety Approval
  UL, cUL, CSA, FIMKO, VDE* Approved
  (*Requires "V" ordering option)
* RoHS compliance

APPLICATIONS

* Hybrid substrates that require high density mounting.
* Programmable controllers
* System appliances, measuring instruments

OUTLINE DIMENSIONS

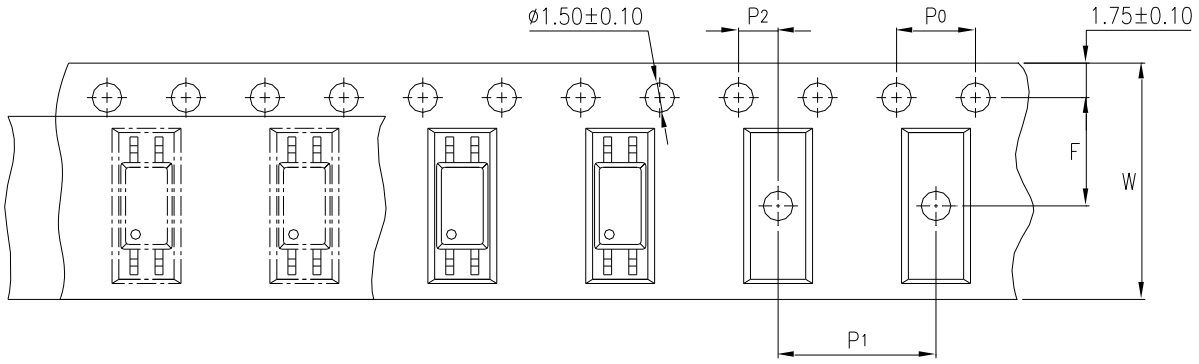
LTV-217-G:



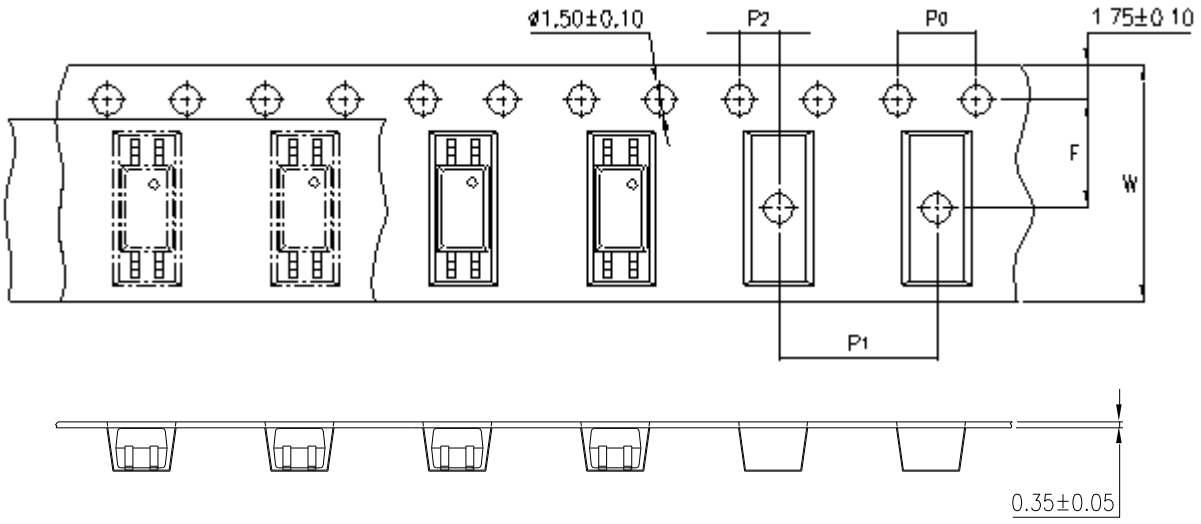
*1. 3-digit date code.
*2. Rank shall be or shall not be marked.
*3. VDE mark, only appears on devices ordered “V” option.

TAPING DIMENSIONS

LTV-217



LTV-217-TP1



Description	Symbol	Dimension in mm (inches)
Tape wide	W	12 ± 0.3 (.47)
Pitch of sprocket holes	P_0	4 ± 0.1 (.15)
Distance of compartment	F P_2	5.5 ± 0.1 (.217) 2 ± 0.1 (.079)
Distance of compartment to compartment	P_1	8 ± 0.1 (.315)

Quantities per Reel :

Package Type	LTV-217
Quantities (pcs)	**3000**

ABSOLUTE MAXIMUM RATING

(Ta = 25°C)

PARAMETER		SYMBOL	RATING	UNIT
INPUT	Forward Current	I_F	50	mA
	Reverse Voltage	V_R	6	V
	Power Dissipation	P	70	mW
OUTPUT	Collector - Emitter Voltage	V_{CEO}	70	V
	Emitter - Collector Voltage	V_{ECO}	7	V
	Collector Current	I_C	50	mA
	Collector Power Dissipation	P_C	150	mW
Total Power Dissipation		Ptot	200	mW
*1 Isolation Voltage		Viso	3000	Vrms
Operating Temperature		Topr	-55 ~ +110	°C
Storage Temperature		Tstg	-55 ~ +150	°C
*2 Soldering Temperature		Tsol	260 (10s)	°C

*1. AC For 1 Minute, R.H. = 40 ~ 60%

Isolation voltage shall be measured using the following method.

(1) Short between anode and cathode on the primary side and between collector and emitter on the secondary side.

(2) The isolation voltage tester with zero-cross circuit shall be used.

(3) The waveform of applied voltage shall be a sine wave.

*2. For 10 Seconds

ELECTRICAL - OPTICAL CHARACTERISTICS

(Ta = 25°C)

PARAMETER		SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS
INPUT	Forward Voltage	V_F	—	1.2	1.4	V	I_F=20mA
	Reverse Current	I_R	—	—	10	μA	V_R=4V
	Terminal Capacitance	C_t	—	30	250	pF	V=0, f=1KHz
OUTPUT	Collector Dark Current	I_{CEO}	—	—	100	nA	V_{CE}=50V, I_F=0
	Collector-Emitter Breakdown Voltage	BV_{CEO}	80	—	—	V	I_C=0.1mA I_F=0
	Emitter-Collector Breakdown Voltage	BV_{ECO}	7	—	—	V	I_E=10μA I_F=0
TRANSFER CHARACTERISTICS	Collector Current	I_C	2.5	—	30	mA	I_F=5mA V_{CE}=5V
	*1 Current Transfer Ratio	CTR	50	—	600	%	
	Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	—	—	0.4	V	I_F=8mA I_C=2.4mA
	Isolation Resistance	R_{iso}	5×10^{10}	1×10^{11}	—	Ω	DC500V 40 ~ 60% R.H.
	Floating Capacitance	C_f	—	0.6	1	pF	V=0, f=1MHz
	Response Time (Rise)	t_r	—	2	18	μs	V_{CE}=10V, I_C=2mA R_L=100Ω, f=100Hz
	Response Time (Fall)	t_f	—	3	18	μs	
	Turn-On Time	t_{on}		3		μs	
	Turn-Off Time	t_{off}		3		μs	

*1 $CTR = \frac{I_C}{I_F} \times 100\%$

RANK TABLE OF CURRENT TRANSFER RATIO CTR

MODEL NO.	RANK MARK	CTR (%)
LTV-217	A	80 ~ 160
	B	130 ~ 260
	C	200 ~ 400
	D	300 ~ 600
	A or B or C or D or No mark	50 ~ 600
CONDITIONS	IF = 5 mA VCE = 5 V Ta = 25 °C	

CHARACTERISTICS CURVES

Figure 1. Collector Power Dissipation vs. Ambient Temperature

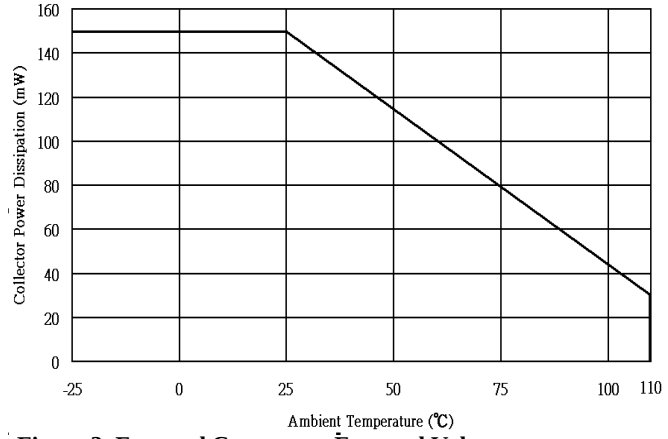


Figure 2. Forward Current vs. Ambient Temperature

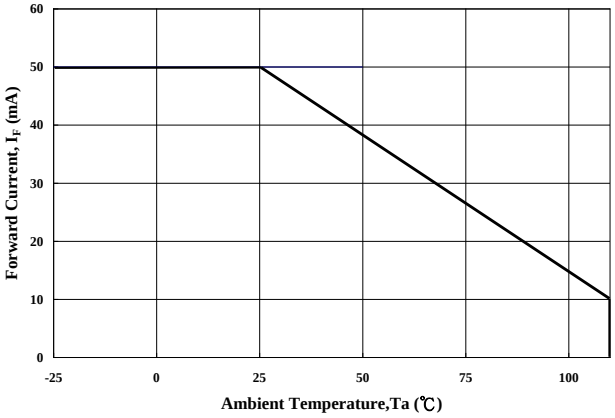


Figure 3. Forward Current vs. Forward Voltage

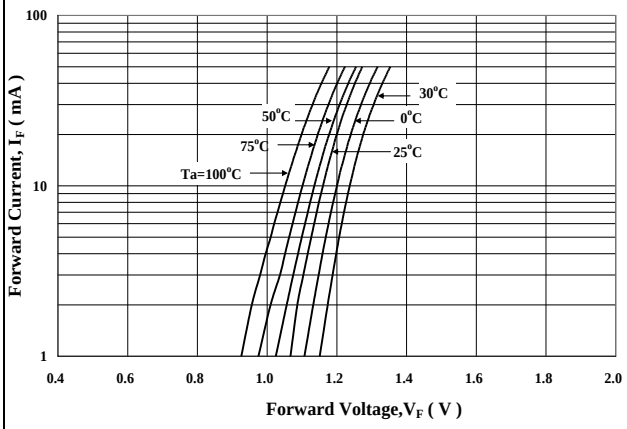


Figure 4. Forward Voltage Temperature Coefficient vs. Forward Current

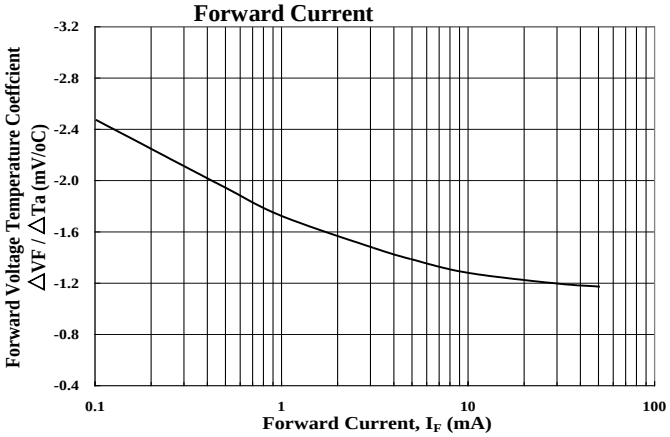


Figure 5. Pulse Forward Current vs. Duty Cycle Ratio

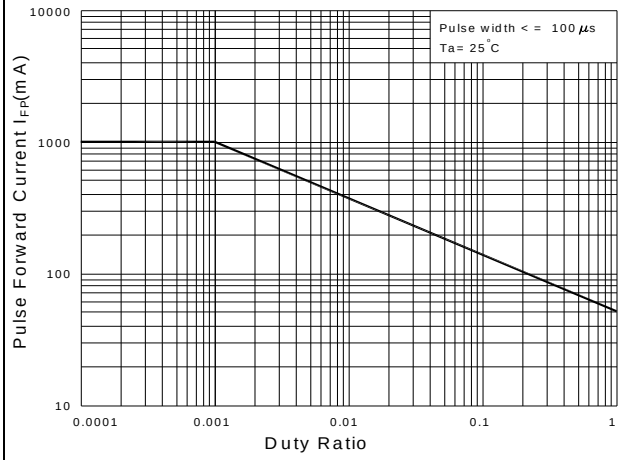
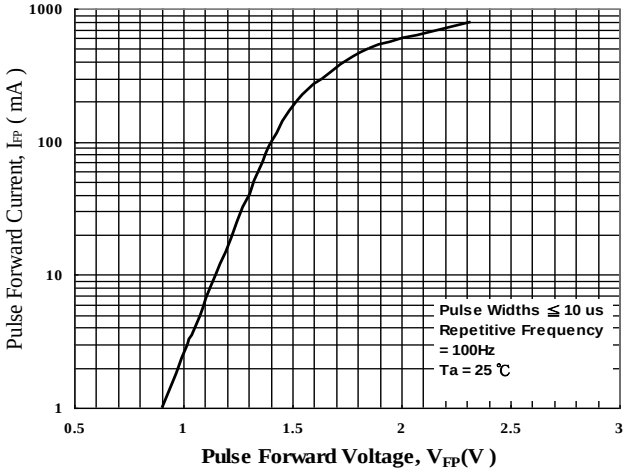


Figure 6. Pulse Forward Current vs. Pulse Forward Voltage



CHARACTERISTICS CURVES

Figure 7. Collector-Emitter Saturation Voltage vs. Forward Current

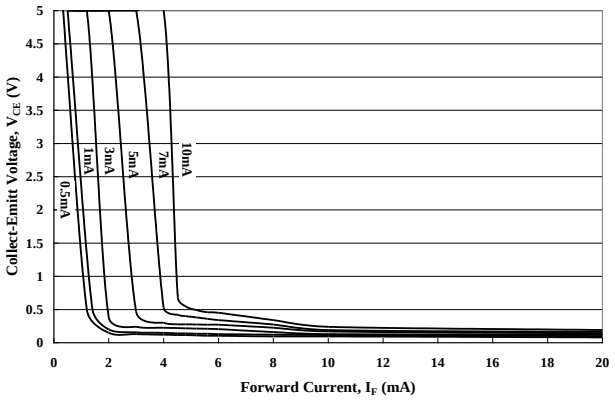


Figure 8. Collector Current vs. Collector-Emitter Voltage

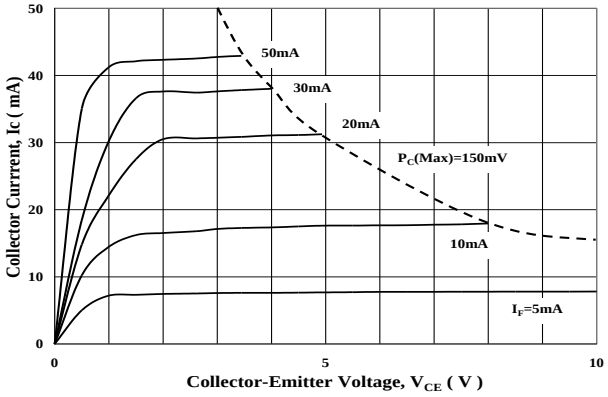


Figure 9. Collector Current vs. Small Collector-Emitter Voltage

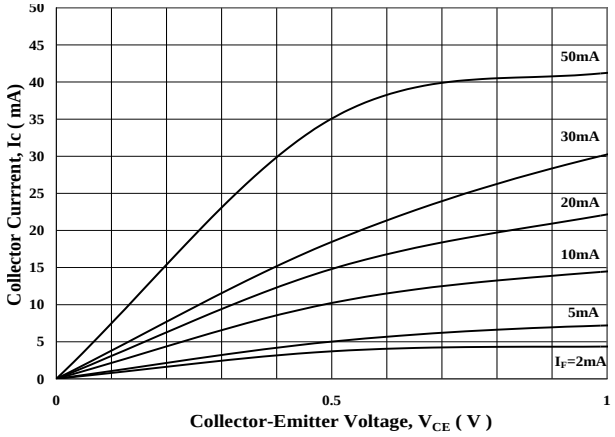


Figure 10. Collector Current vs. Forward Curent

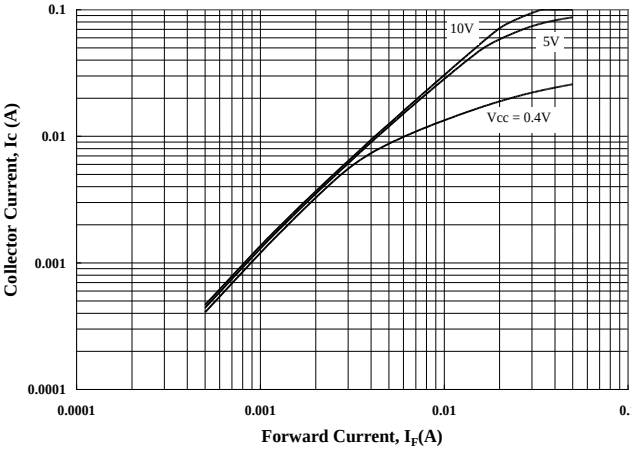


Figure 11. Collector Dark Current vs. Ambient Temperature

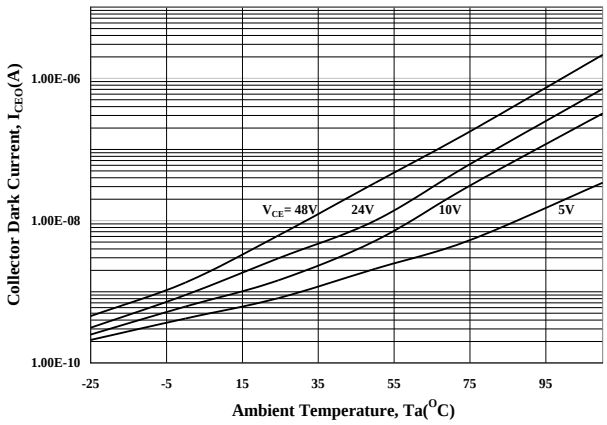
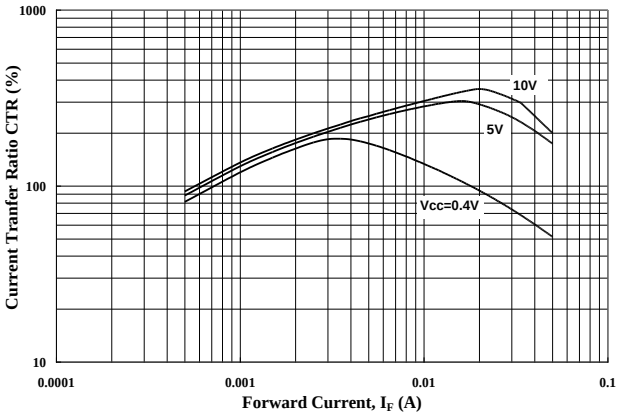


Figure 12. Current Transfer Ratio vs. Forward Current



CHARACTERISTICS CURVES

Figure 13. Collector-Emitter Saturation Voltage vs. Ambient Temperature

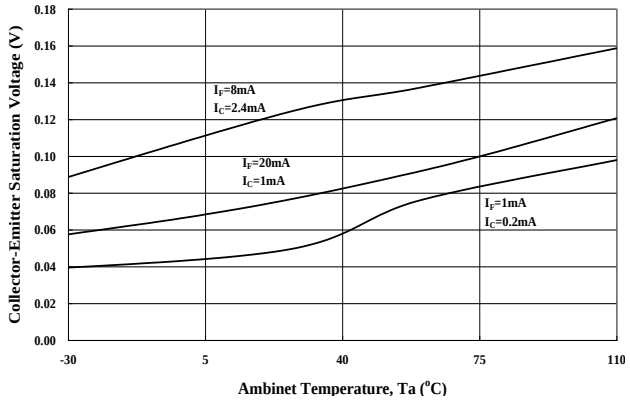


Figure 14. Collector Current vs. Ambient Temperature

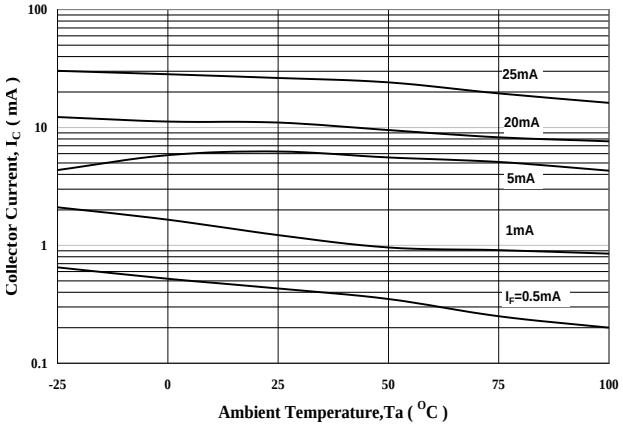


Figure 15. Switching Time vs. Load Resistance

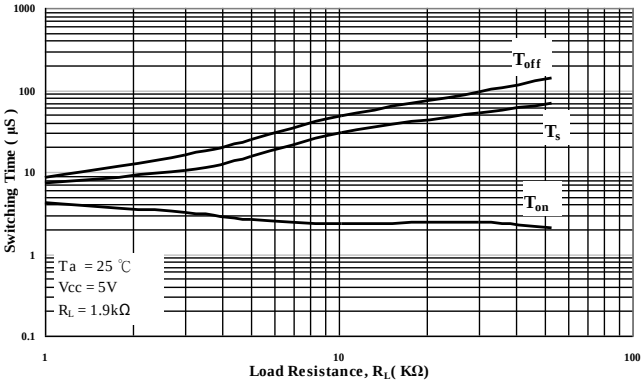


Figure 16. Switching Time vs. Ambient Temperature

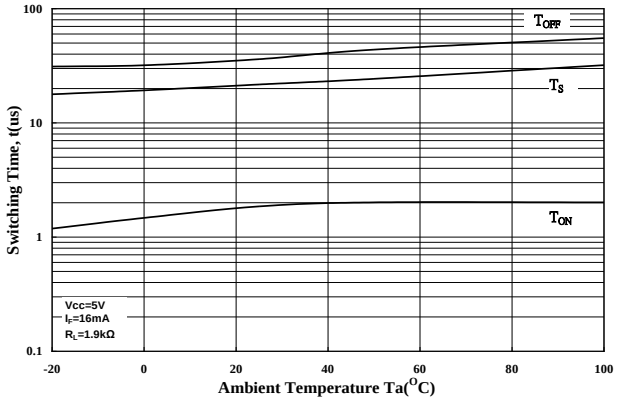
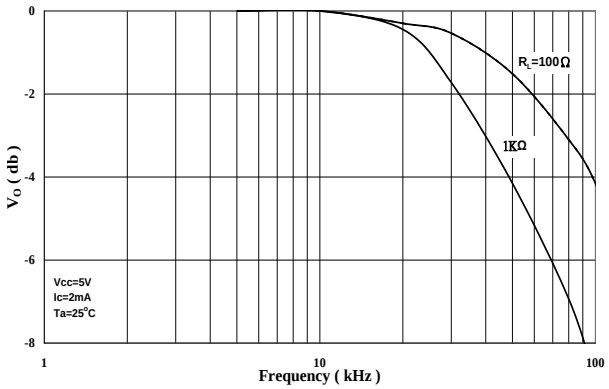
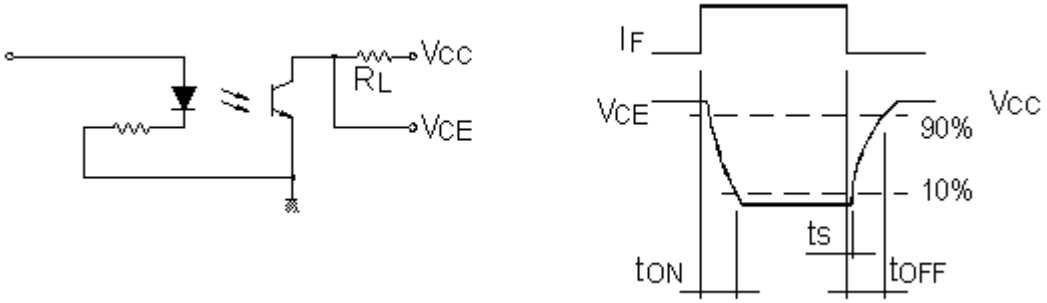


Figure 17. Frequency Response



SWITCHING TIME TEST CIRCUIT



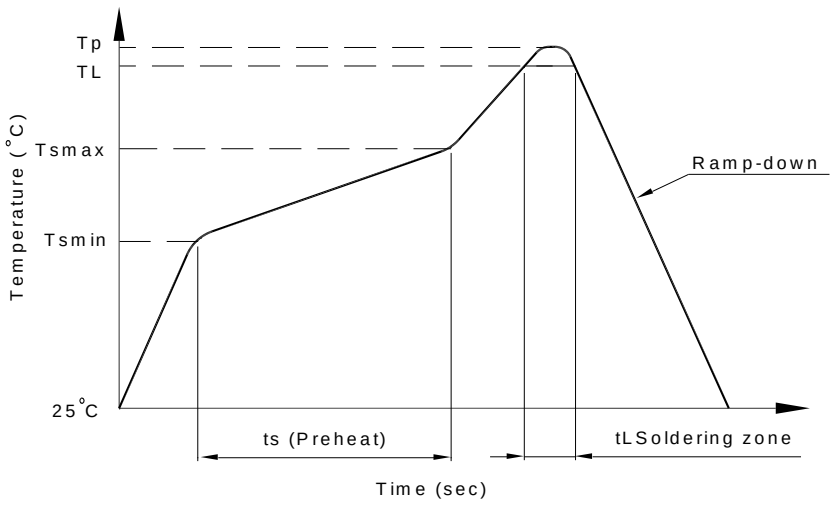
TEMPERATURE PROFILE OF SOLDERING REFLOW

(1) One time soldering reflow is recommended within the condition of temperature and time profile shown below.

1. Wave solder
   - 260˚C / 10 sec.

2. IR Reflow

Profile item	Conditions
Preheat - Temperature Min (T_{Smin}) - Temperature Max (T_{Smax}) - Time (min to max) (ts)	 150˚C 180˚C 90±30˚C
Soldering zone - Temperature (T_L) - Time (t_L)	 250˚C 10~15 sec
Peak Temperature (T_P)	260˚C
Ramp-down rate	3~6˚C / sec



TEMPERATURE PROFILE OF SOLDERING REFLOW

(2) When using another soldering method such as infrared ray lamp, the temperature may rise partially in the mold of the device.
Keep the temperature on the package of the device within the condition of above (1)

(3) When using another soldering method such as infrared ray lamp, the temperature may rise partially in the mold of the device.
Keep the temperature on the package of the device within the condition of above (1)

Notes:

- Lite-On is continually improving the quality, reliability, function or design and Lite-On reserves the right to make changes without further notices.
- The products shown in this publication are designed for the general use in electronic applications such as office automation equipment, communications devices, audio/visual equipment, electrical application and instrumentation.
- For equipment/devices where high reliability or safety is required, such as space applications, nuclear power control equipment, medical equipment, etc, please contact our sales representatives.
- When requiring a device for any ”specific” application, please contact our sales in advice.
- If there are any questions about the contents of this publication, please contact us at your convenience.
- The contents described herein are subject to change without prior notice.
- Immerge unit’s body in solder paste is not recommended.